

Preliminary



CDR6008

1. Electrical Characteristics

This filter satisfies Table 1 at Temperature Range : -40 to +85°C

CENTER FREQUENCY :fo=1230 MHz

PASSBAND WIDTH :1160~1300 MHz

INPUT/OUTPUT IMPEDANCE :50 Ω

Max. INPUT POWER : 1 W

MOISTURE SENSITIVITY LEVEL: 2A

1230 MHz Ceramic Filter

Package Dimensions

8.4 x 5.35 x 2.8

| NO | ITEM | | SPECIFICATION | |
|--|--------------------------|-------------|---------------|--------|
| NO. | | | min | max |
| 1 | PASS BAND INSERTION LOSS | | | 1.7 dB |
| 2 | PASS BAND RIPPLE | | | 1.0 dB |
| 3 | PASS BAND RETURN LOSS | | 9 dB | |
| 4 | STOP—BAND ATTENUATION | at 1000 MHz | 20 dB | |
| | | at 1525 MHz | 20 dB | |
| Item NO.4 specifies the absolute value of attenuation. | | | | |

TABLE 1

*****Data is measured EVBboard





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3. Recommended Reflow Soldering Profile

| Phase | Profile features | Pb-Free Assembly (SnAgCu) | |
|------------------|---|------------------------------------|--|
| PREHEAT | -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(ts) form (Tsmin to Tsmax) | 150° C 200° C 60-180 seconds | |
| RAMP-UP | Avg. Ramp-up Rate (Tsmax to TP) | 3° C /seconds max | |
| REFLOW | -Temperature(TL) -Total Time above TL (t L) | 217° C 60-150 seconds | |
| PEAK | -Temperature(TP) -Time(tp) | 260° C 20-40 seconds | |
| RAMP-DOWN | Rate | 6° C /seconds max | |
| Time from 25°C t | to Peak Temperature | 8 minutes max | |
| Composition of s | older paste | 96.5Sn/3Ag/0.5Cu | |
| Solder Paste Mod | lel | SHENMAO PF606-P26 | |

The products can be assembled following Pb-free assembly. According to the Standard **IPC**/**JEDEC J-STD-020C**, the temperature profile suggested is as follow:

Note: All the temperature measure point is on top surface of the component, if temperature over recommend, it will make component surface peeling or damage.





Soldering With Iron:

Soldering condition : Soldering iron temperature 270 ± 10 °C

Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron over temperature 270±10 °C or3 seconds, it will make component surface peeling or damage. Soldering iron can not leakage of electricity.

4.DIMENSION AND PCB LAYOUT

4-1 SHAPE AND DIMENSION



4-2 PCB RECOMMENDED PATTERN FOR FILTER





- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.